

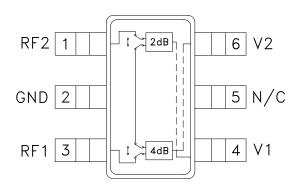
2 dB LSB GaAs MMIC 2-BIT DIGITAL ATTENUATOR, 0.7 - 4.0 GHz

Typical Applications

The HMC290 is ideal for:

- Cellular
- PCS, ISM, MMDS
- WLL Handset & BaseStation

Functional Diagram



Features

2 dB LSB Steps to 6 dB
Single Positive Control Per BIT
+/-0.2 dB Typical Bit Error
Miniature SOT 26 Package: 9 mm²

General Description

The HMC290 is a broadband 2 - bit positive control GaAs IC digital attenuator in a 6 lead SOT26 surface mount plastic package. Covering 0.7 to 4 GHz, the insertion loss is typically less than 0.7 dB. The attenuator bit values are 2 (LSB) and 4 dB for a total attenuation of 6 dB. Accuracy is excellent at \pm 0.2 dB typical with an IIP3 of up to +52 dBm. Two bit control voltage inputs, toggled between 0 and +3 to +5 volts, are used to select each attenuation state at less than 50 uA each. A single Vdd bias of +3 to +5 volts applied through an external 5K Ohm resistor is required. Occupying less than 9 mm², this is the smallest 2 - bit digital attenuator available.

Electrical Specifications,

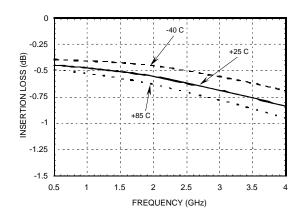
 $T_A = +25^{\circ}$ C, Vdd = +3V to +5V & Vctl = 0/Vdd (Unless Otherwise Stated)

Parameter		Frequency	Min.	Typical	Max.	Units
Insertion Loss		0.7 - 1.4 GHz 1.4 - 2.3 GHz 2.3 - 2.7 GHz 2.7 - 4.0 GHz		0.5 0.5 0.6 0.8	0.7 0.8 0.9 1.2	dB dB dB dB
Attenuation Range		0.7 - 4.0 GHz		6		dB
Return Loss (RF1 & RF2, All Atten. States)		0.7 - 2.7 GHz 2.7 - 4.0 GHz	16 15	20 18		dB dB
Attenuation Accuracy: (Referenced to Insertion Loss)						
2, 4 dB States 6 dB States		0.7 - 4.0 GHz 0.7 - 4.0 GHz	± 0.2 + 2% of Atten. Setting Max ± 0.3 + 2% of Atten. Setting Max		dB dB	
Input Power for 0.1 dB Compression	5V 3V	0.7 - 4.0 GHz		27 24		dBm dBm
Input Third Order Intercept Point (Two-tone Input Power = 0 dBm Each Tone)	5V 3V	0.7 - 4.0 GHz		52 50		dBm dBm
Switching Characteristics		0.7 - 4.0 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)				400 420		ns ns

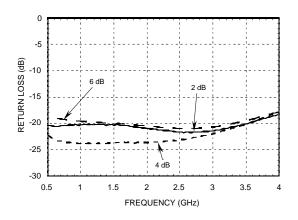


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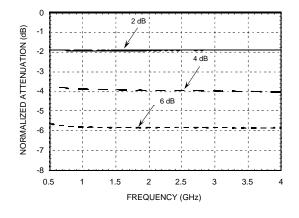
Insertion Loss



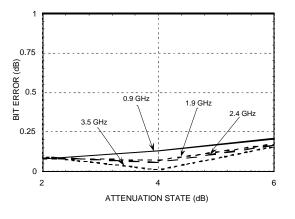
Return Loss RF1, RF2



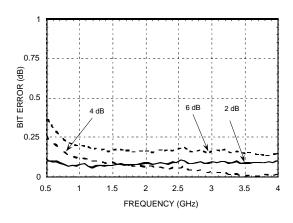
Normalized Attenuation



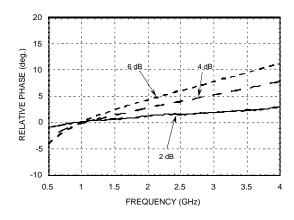
Absolute Bit Error vs. Attenuation State



Absolute Bit Error vs. Frequency



Relative Phase vs. Frequency



Note: All Data Typical Over Voltage (+3V to +5V) & Temperature (-40 to +85 deg. C.).



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Truth Table

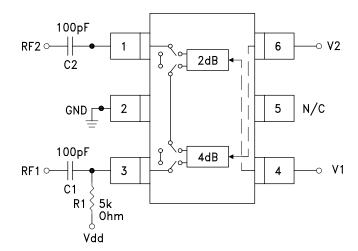
Control Voltage Input		Attenuation	
V2 4 dB	V1 2 dB	Setting RF1 - RF2	
High	High	Reference I.L.	
High	Low	2 dB	
Low	High	4 dB	
Low Low		6 dB Max. Atten.	

Any combination of the above states will provide an attenuation approximately equal to the sum of the bits selected.

Control & Bias Voltages

State	Bias Condition	
Low	0 to + 0.2V @ 20 uA Max	
High	Vdd ± 0.2V @ 50 uA Max	
Note: Vdd = +3V to 5V ± 0.2V		

Application Circuit



DC blocking capacitors C1 & C2 are required on RF1 & RF2. Choose C1 = $C2 = 100 \sim 300$ pF to allow lowest customer specific frequency to pass with minimal loss. R1 = 5K Ohm is required to supply voltage to the circuit throught either PIN 3 or PIN 1.

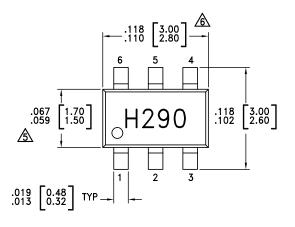


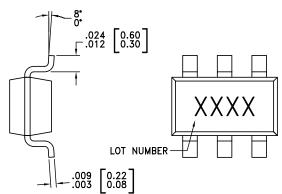
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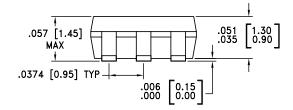
Absolute Maximum Ratings

Control Voltage (V1, V2)	Vdd + 0.5 Vdc	
Bias Voltage (Vdd)	+ 8.0 Vdc	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
RF Input Power (0.7 - 4 GHz)	+28 dBm	

Outline Drawing







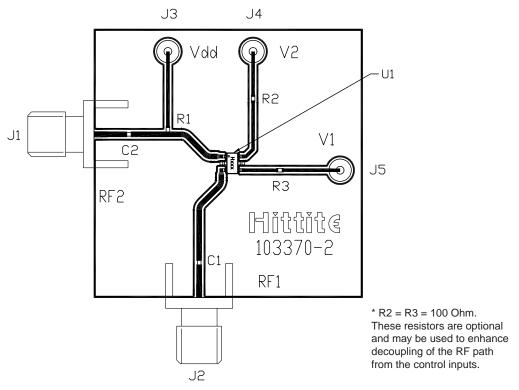
NOTES

- PACKAGE BODY MATERIAL: LOW STRESS INJECTION MOLDED PLASTIC SILICA AND SILICON IMPREGNATED.
- 2. LEADFRAME MATERIAL: COPPER ALLOY
- 3. LEADFRAME PLATING: Sn/Pb SOLDER
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- ⚠ DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- 7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.



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Evaluation Circuit Board



The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board as shown is available from Hittite Microwave Corporation upon request.

List of Material

Item	Description	
J1 - J2	PC Mount SMA Connector	
J3 - J6	DC Pin	
R1	5k Ohm Resistor, 0402 Chip	
R2, R3	100 Ohm Resistor, 0402 Chip	
C1, C2	0402 Chip Capacitor, Select for Lowest Frequency of Operation	
U1	HMC290 Digital Attenuator	
PCB*	103370 Evaluation PCB 1.5" x 1.5"	
*Circuit Board Material: Rogers 4350		



v00.0600



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Notes: